



## N-Channel 250-V (D-S) 175 °C MOSFET

## PRODUCT SUMMARY

| $V_{(BR)DSS}$ (V) | $r_{DS(on)}$ ( $\Omega$ ) | $I_D$ (A) |
|-------------------|---------------------------|-----------|
| 250               | 0.058 at $V_{GS} = 10$ V  | 45        |
|                   | 0.062 at $V_{GS} = 6$ V   | 43        |

## FEATURES

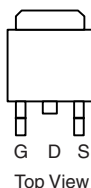
- TrenchFET® Power MOSFETS
- 175 °C Junction Temperature
- New Low Thermal Resistance Package

RoHS  
COMPLIANT

## APPLICATIONS

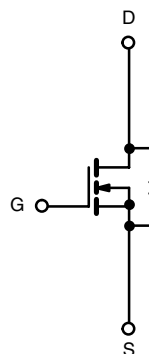
- Primary Side Switch
- Plasma Display Panel Sustainer Function

TO-263



Top View

Ordering Information: SUM45N25-58-E3 (Lead (Pb)-free)



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS  $T_C = 25$  °C, unless otherwise noted

| Parameter                                        | Symbol                              | Limit            | Unit |
|--------------------------------------------------|-------------------------------------|------------------|------|
| Drain-Source Voltage                             | $V_{DS}$                            | 250              | V    |
| Typical Avalanche Voltage <sup>d</sup>           | $V_{DS}$ (Avalanche) <sub>Typ</sub> | 300              |      |
| Gate-Source Voltage                              | $V_{GS}$                            | $\pm 30$         |      |
| Continuous Drain Current ( $T_J = 175$ °C)       | $I_D$                               | 45               | A    |
|                                                  |                                     | 25               |      |
| Pulsed Drain Current                             | $I_{DM}$                            | 90               |      |
| Avalanche Current                                | $I_{AR}$                            | 35               | mJ   |
| Repetitive Avalanche Energy <sup>a</sup>         | $E_{AR}$                            | 61               |      |
| Maximum Power Dissipation <sup>a</sup>           | $P_D$                               | 375 <sup>b</sup> | W    |
|                                                  |                                     | 3.75             |      |
| Operating Junction and Storage Temperature Range | $T_J, T_{stg}$                      | - 55 to 175      | °C   |

## THERMAL RESISTANCE RATINGS

| Parameter                                    | Symbol     | Limit | Unit |
|----------------------------------------------|------------|-------|------|
| Junction-to-Ambient (PCB Mount) <sup>c</sup> | $R_{thJA}$ | 40    | °C/W |
| Junction-to-Case (Drain)                     | $R_{thJC}$ | 0.4   |      |

Notes:

a. Duty cycle  $\leq 1$  %.

b. See SOA curve for voltage derating.

c. When Mounted on 1" square PCB (FR-4 material).

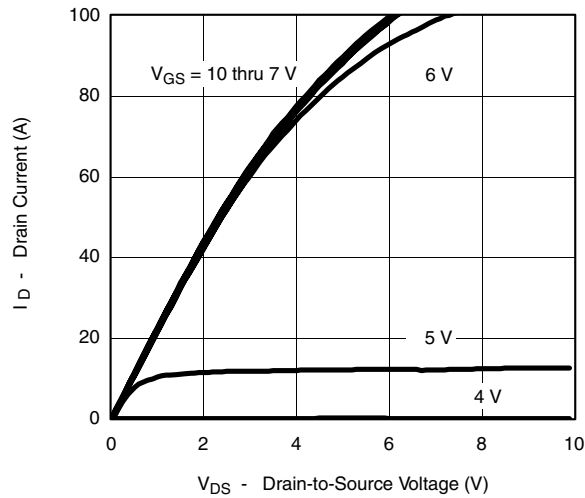
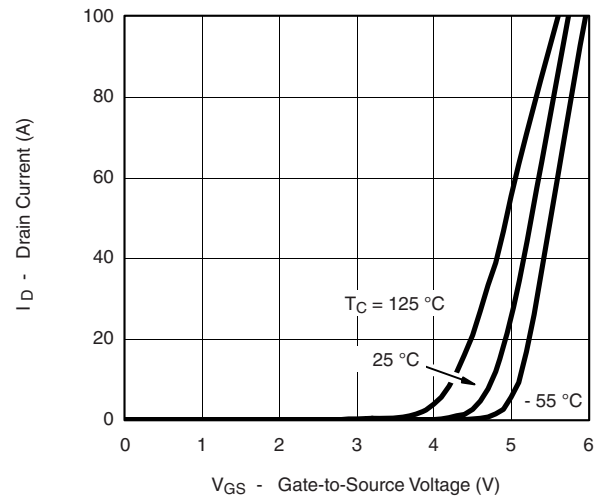
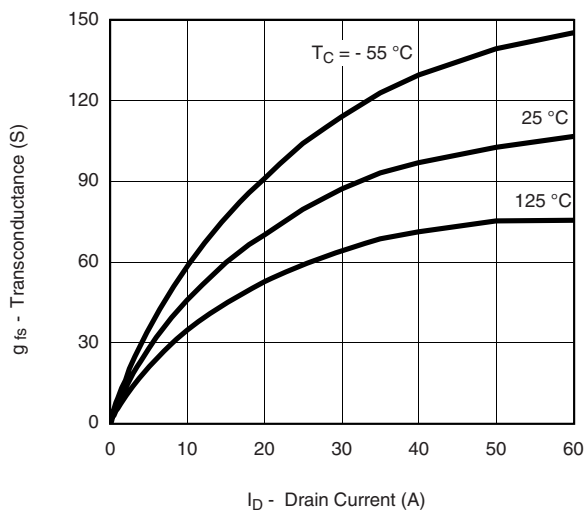
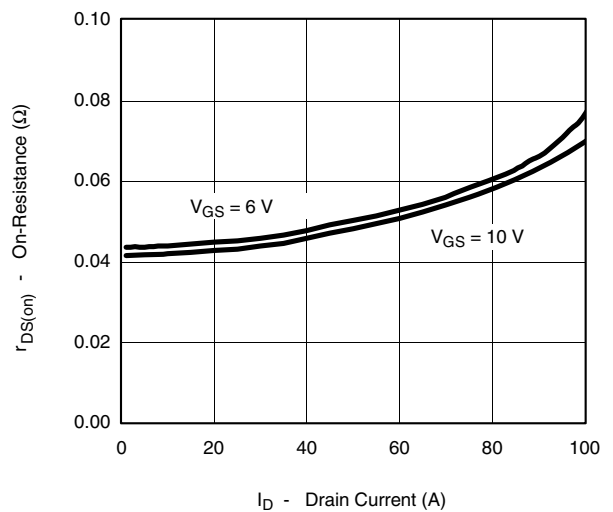
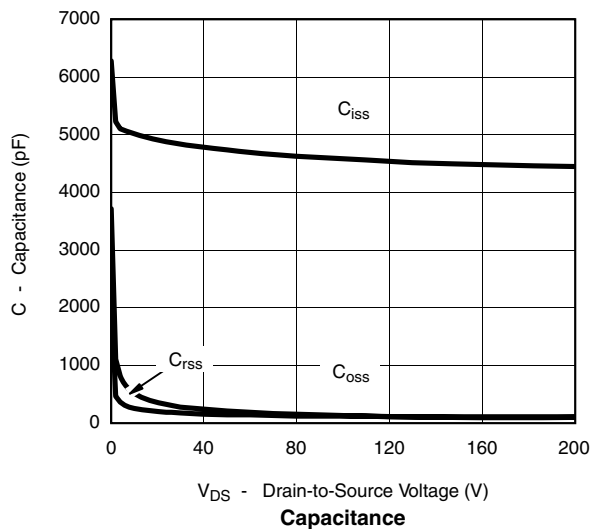
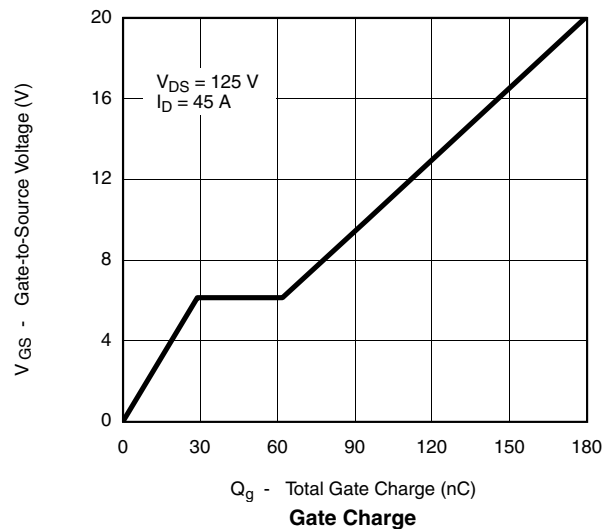
d. Guaranteed by design

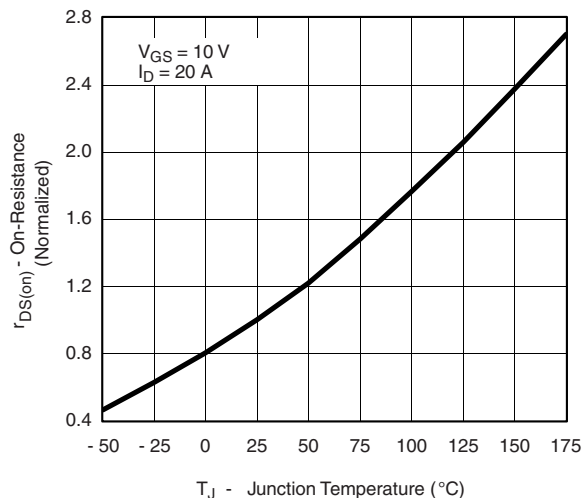
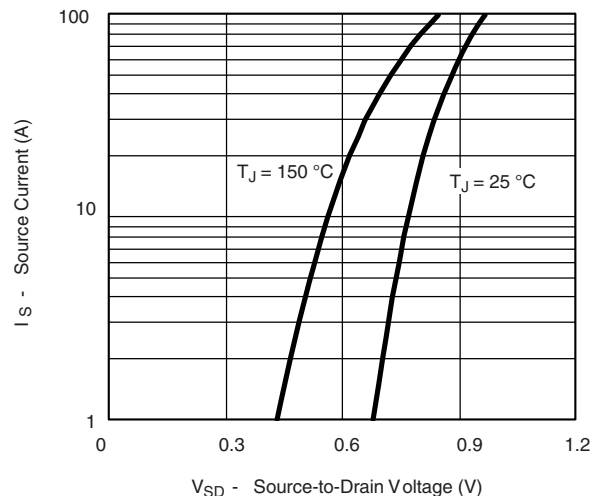
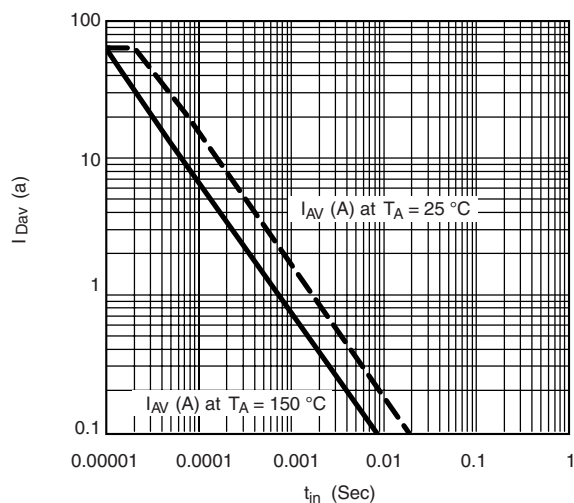
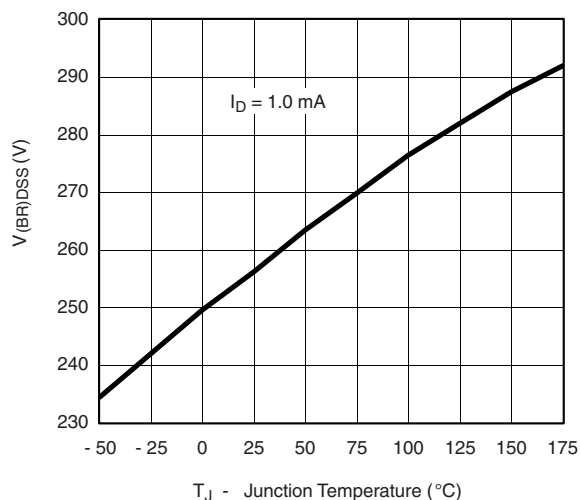
| SPECIFICATIONS $T_J = 25\text{ }^{\circ}\text{C}$ , unless otherwise noted                         |               |                                                                                                                                       |     |       |           |               |
|----------------------------------------------------------------------------------------------------|---------------|---------------------------------------------------------------------------------------------------------------------------------------|-----|-------|-----------|---------------|
| Parameter                                                                                          | Symbol        | Test Conditions                                                                                                                       | Min | Typ   | Max       | Unit          |
| Static                                                                                             |               |                                                                                                                                       |     |       |           |               |
| Drain-Source Breakdown Voltage                                                                     | $V_{(BR)DSS}$ | $V_{DS} = 0\text{ V}$ , $I_D = 250\text{ }\mu\text{A}$                                                                                | 250 |       |           | V             |
| Gate-Threshold Voltage                                                                             | $V_{GS(th)}$  | $V_{DS} = V_{GS}$ , $I_D = 250\text{ }\mu\text{A}$                                                                                    | 2   |       | 4         |               |
| Gate-Body Leakage                                                                                  | $I_{GSS}$     | $V_{DS} = 0\text{ V}$ , $V_{GS} = \pm 30\text{ V}$                                                                                    |     |       | $\pm 250$ | nA            |
| Zero Gate Voltage Drain Current                                                                    | $I_{DSS}$     | $V_{DS} = 250\text{ V}$ , $V_{GS} = 0\text{ V}$                                                                                       |     |       | 1         | $\mu\text{A}$ |
|                                                                                                    |               | $V_{DS} = 250\text{ V}$ , $V_{GS} = 0\text{ V}$ , $T_J = 125\text{ }^{\circ}\text{C}$                                                 |     |       | 50        |               |
|                                                                                                    |               | $V_{DS} = 250\text{ V}$ , $V_{GS} = 0\text{ V}$ , $T_J = 175\text{ }^{\circ}\text{C}$                                                 |     |       | 250       |               |
| On-State Drain Current <sup>a</sup>                                                                | $I_{D(on)}$   | $V_{DS} \geq 5\text{ V}$ , $V_{GS} = 10\text{ V}$                                                                                     | 70  |       |           | A             |
| Drain-Source On-State Resistance <sup>a</sup>                                                      | $r_{DS(on)}$  | $V_{GS} = 10\text{ V}$ , $I_D = 20\text{ A}$                                                                                          |     | 0.047 | 0.058     | $\Omega$      |
|                                                                                                    |               | $V_{GS} = 10\text{ V}$ , $I_D = 20\text{ A}$ , $T_J = 125\text{ }^{\circ}\text{C}$                                                    |     |       | 0.121     |               |
|                                                                                                    |               | $V_{GS} = 10\text{ V}$ , $I_D = 20\text{ A}$ , $T_J = 175\text{ }^{\circ}\text{C}$                                                    |     |       | 0.163     |               |
|                                                                                                    |               | $V_{GS} = 6\text{ V}$ , $I_D = 15\text{ A}$                                                                                           |     | 0.049 | 0.062     |               |
| Forward Transconductance <sup>a</sup>                                                              | $g_{fs}$      | $V_{DS} = 15\text{ V}$ , $I_D = 20\text{ A}$                                                                                          |     | 70    |           | S             |
| Dynamic <sup>b</sup>                                                                               |               |                                                                                                                                       |     |       |           |               |
| Input Capacitance                                                                                  | $C_{iss}$     | $V_{GS} = 0\text{ V}$ , $V_{DS} = 25\text{ V}$ , $f = 1\text{ MHz}$                                                                   |     | 5000  |           | pF            |
| Output Capacitance                                                                                 | $C_{oss}$     |                                                                                                                                       |     | 300   |           |               |
| Reverse Transfer Capacitance                                                                       | $C_{rss}$     |                                                                                                                                       |     | 170   |           |               |
| Total Gate Charge <sup>c</sup>                                                                     | $Q_g$         | $V_{DS} = 125\text{ V}$ , $V_{GS} = 10\text{ V}$ , $I_D = 45\text{ A}$                                                                |     | 95    | 140       | nC            |
| Gate-Source Charge <sup>c</sup>                                                                    | $Q_{gs}$      |                                                                                                                                       |     | 28    |           |               |
| Gate-Drain Charge <sup>c</sup>                                                                     | $Q_{gd}$      |                                                                                                                                       |     | 34    |           |               |
| Gate Resistance                                                                                    | $R_g$         | $f = 1\text{ MHz}$                                                                                                                    |     | 1.6   |           | $\Omega$      |
| Turn-On Delay Time <sup>c</sup>                                                                    | $t_{d(on)}$   | $V_{DD} = 100\text{ V}$ , $R_L = 2.78\text{ }\Omega$<br>$I_D \cong 45\text{ A}$ , $V_{GEN} = 10\text{ V}$ , $R_g = 2.5\text{ }\Omega$ |     | 22    | 35        | ns            |
| Rise Time <sup>c</sup>                                                                             | $t_r$         |                                                                                                                                       |     | 220   | 330       |               |
| Turn-Off Delay Time <sup>c</sup>                                                                   | $t_{d(off)}$  |                                                                                                                                       |     | 40    | 60        |               |
| Fall Time <sup>c</sup>                                                                             | $t_f$         |                                                                                                                                       |     | 145   | 220       |               |
| Source-Drain Diode Ratings and Characteristics ( $T_C = 25\text{ }^{\circ}\text{C}$ ) <sup>b</sup> |               |                                                                                                                                       |     |       |           |               |
| Continuous Current                                                                                 | $I_S$         |                                                                                                                                       |     |       | 45        | A             |
| Pulsed Current                                                                                     | $I_{SM}$      |                                                                                                                                       |     |       | 70        |               |
| Forward Voltage <sup>a</sup>                                                                       | $V_{SD}$      | $I_F = 45\text{ A}$ , $V_{GS} = 0\text{ V}$                                                                                           |     | 1.0   | 1.5       | V             |
| Reverse Recovery Time                                                                              | $t_{rr}$      | $I_F = 45\text{ A}$ , $di/dt = 100\text{ A}/\mu\text{s}$                                                                              |     | 150   | 225       | ns            |
| Peak Reverse Recovery Current                                                                      | $I_{RM(REC)}$ |                                                                                                                                       |     | 12    | 18        | A             |
| Reverse Recovery Charge                                                                            | $Q_{rr}$      |                                                                                                                                       |     | 0.9   | 2         | $\mu\text{C}$ |

## Notes:

- a. Pulse test; pulse width  $\leq 300\text{ }\mu\text{s}$ , duty cycle  $\leq 2\%$   
b. Guaranteed by design, not subject to production testing.  
c. Independent of operating temperature.

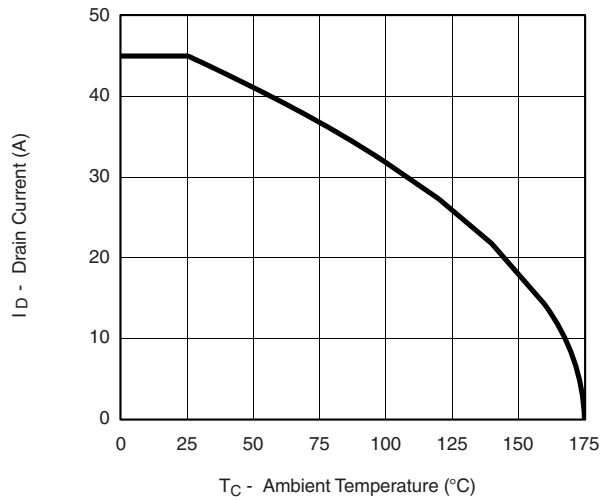
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

**TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted**Output Characteristics****Transfer Characteristics****Transconductance****On-Resistance vs. Drain Current****Capacitance****Gate Charge**

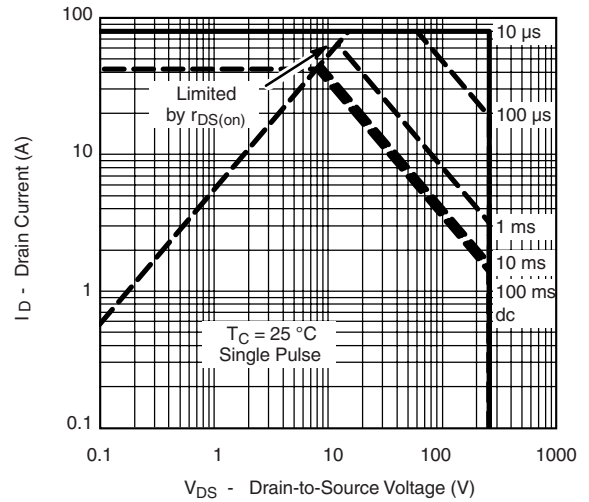
**TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted**On-Resistance vs. Junction Temperature****Source-Drain Diode Forward Voltage****Avalanche Current vs. Time****Drain Source Breakdown vs. Junction Temperature**



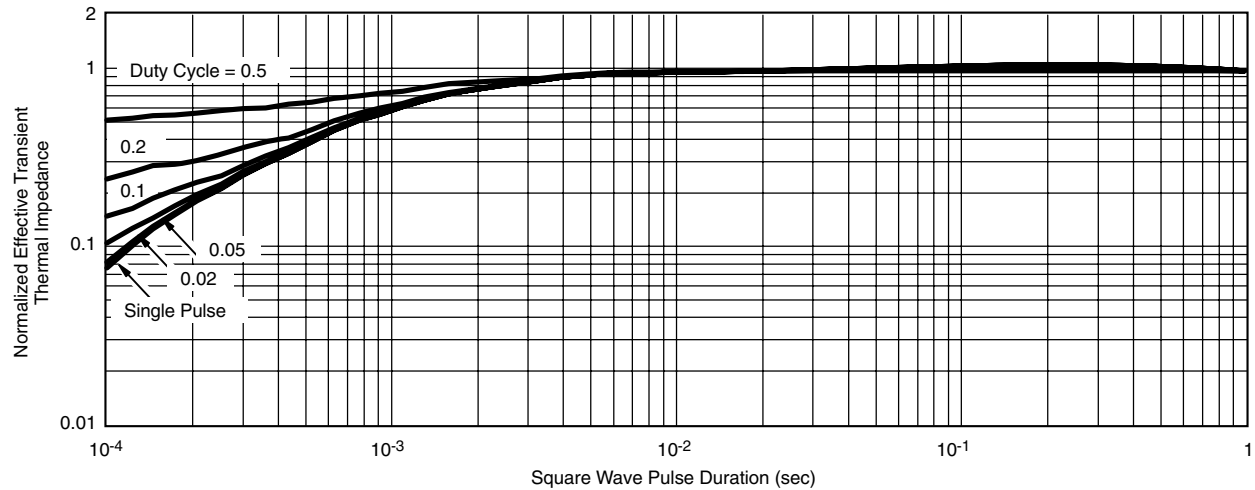
## THERMAL RATINGS



Maximum Avalanche and Drain Current  
vs. Case Temperature



Safe Operating Area, Case Temperature



Normalized Thermal Transient Impedance, Junction-to-Case

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